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Kind regards,

Team Nexperia

Product data sheet

1. General description

LED driver consisting of a resistor-equipped PNP transistor with two diodes on one chip in a small SOT23 plastic package.

2. Features and benefits

- Stabilized output current of 10 mA
- High currrent accuracy at supply voltage variation
- Reduces component count and board space
- Qualified according to AEC-Q101

3. Applications

- Constant current LED driver
- Generic constant current source
- Automotive applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _O	output current	V_{SUP} = 10 V; V_{O} = 8.6 V; T_{amb} = 25 °C; pulsed; $t_{p} \le 300 \ \mu s$; $\delta \le 0.02$	8.5	10	11.5	mA
V _{SUP}	supply voltage		-	-	18	V





10 mA LED driver in SOT23

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	GND	ground	3	Vsup
2	V _{SUP}	supply voltage		
3	I _O /V _O	output current/output voltage	1 2 TO-236AB (SOT23)	GND IO LED aaa-019596

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
NCR401T	TO-236AB	plastic surface-mounted package; 3 leads	SOT23			

7. Marking

Table 4. Marking codes

Type number	Marking code
NCR401T	BE

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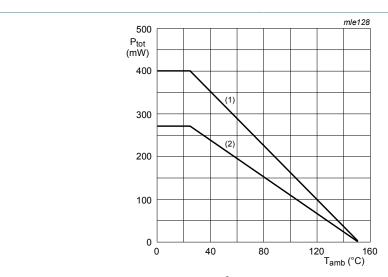
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{SUP}	supply voltage			-	18	V
Vo	output voltage	V _{SUP} = 18 V		-	16	V
V_R	reverse voltage		[1]	-	0.5	V
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	270	mW
			[3]	-	400	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

- [1] Between all terminals.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB); single-sided copper; tin-plated and standard footprint.
- Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for output 1 cm².



- (1) FR4 PCB mounting pad for collector 1 cm²
- (2) FR4 PCB, standard footprint

Fig. 1. Power derating curves

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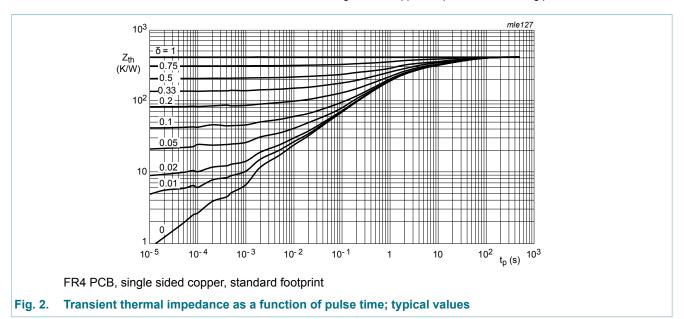
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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ang a)	thermal resistance	in free air	[1]	-	-	465	K/W
	from junction to ambient		[2]	-	-	312	K/W

- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated and mounting pad for collector 1 cm².



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10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _O	output current	V_{SUP} = 10 V; V_{O} = 8.6 V; T_{amb} = 25 °C; pulsed; $t_{p} \le 300 \ \mu s$; $\delta \le 0.02$	8.5	10	11.5	mA
I_{GND}	ground current	V_{SUP} = 10 V; I_{O} = 0 A; T_{amb} = 25 °C; pulsed; $t_{p} \le 300 \ \mu s$; $\delta \le 0.02$	340	420	500	μА
$V_{(VSUP-VO)min}$	minimum voltage between supply voltage and output voltage	$I_O > 8.5$ mA; $T_{amb} = 25$ °C; pulsed; $t_p \le 300$ µs; $\delta \le 0.02$	-	1.4	-	V
$\Delta I_O / (I_O \times \Delta T_{amb})$	relative output current variation with ambient temperature	V_{SUP} = 10 V; V_{O} = 8.6 V; T_{amb} = 25 °C; pulsed; t_{p} ≤ 300 μs; δ ≤ 0.02	-	-0.3	-	%/K
$\Delta I_{O}/$ $(I_{O} \times \Delta V_{SUP})$	relative output current variation with supply voltage	V_{SUP} = 10 V; V_{SUP} - V_{O} = 1.4 V; T_{amb} = 25 °C; pulsed; $t_p \le 300 \ \mu s$; $\delta \le 0.02$	-	0.8	-	%/V

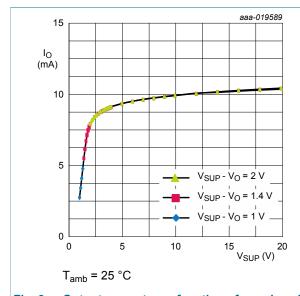


Fig. 3. Output current as a function of supply voltage; typical values

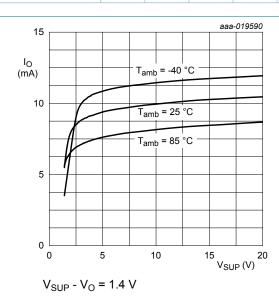
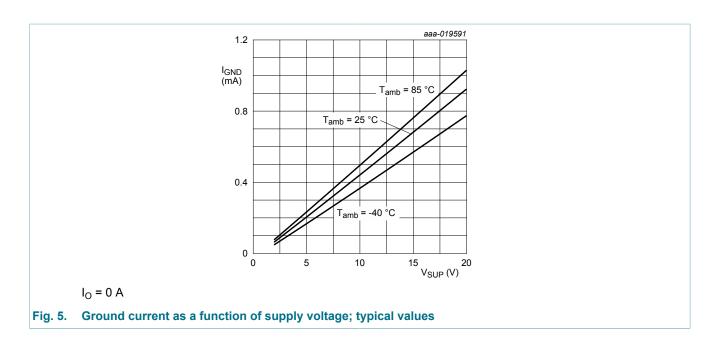


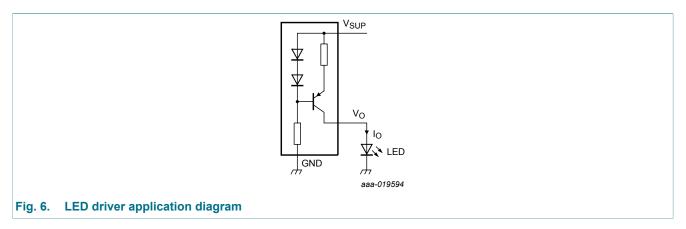
Fig. 4. Output current as a function of supply voltage; typical values

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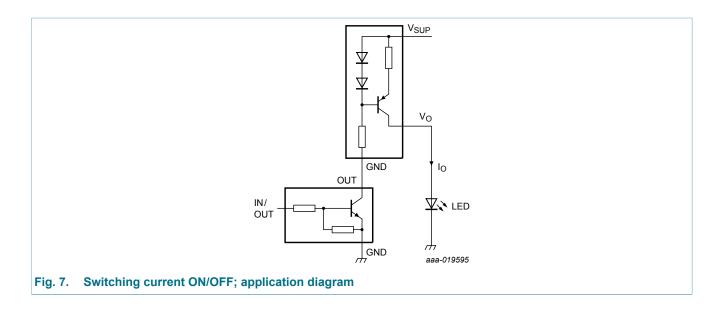
11. Application information

<u>Fig. 6</u> shows a typical application circuit for an LED driver. The constant current ensures a constant LED brightness. The output current slightly decreases when the power load at the LED driver increases. This effect is due to self heating of the device and the negative thermal coefficient of the output current.



The output can be switched ON and OFF by connecting a Resistor-Equipped Transistor (RET), e.g. PDTC124XU; see Fig. 7

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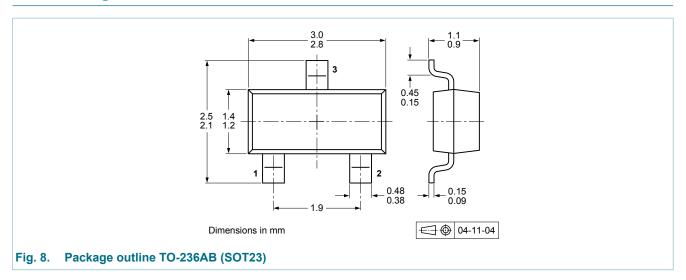


12. Test information

12.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

13. Package outline

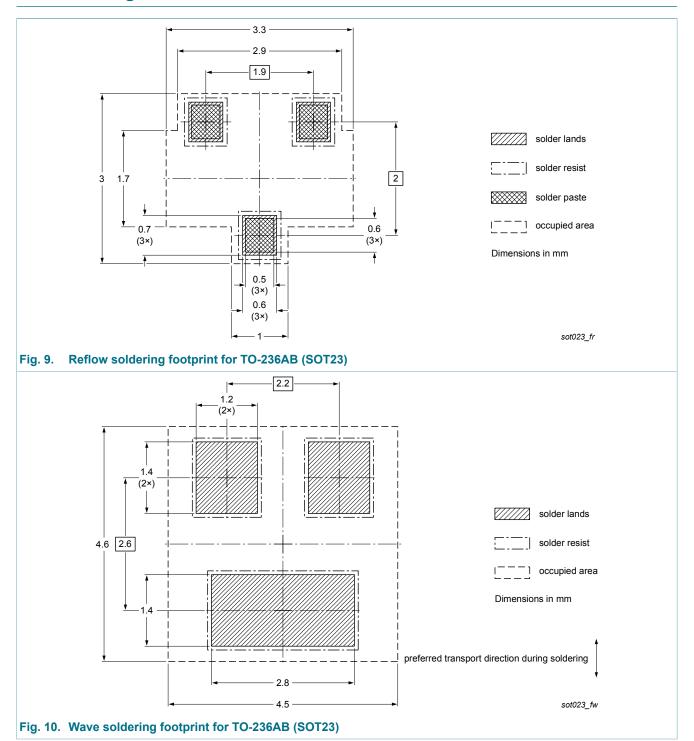


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14. Soldering



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15. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
NCR401T v.1	20151016	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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NCR401T

10 mA LED driver in SOT23

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